PATENT ASSIGNMENT

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|--------------|----------------|
| Yuji WADA | 09/16/2008 |
| Takao NOZAWA | 09/16/2008 |

RECEIVING PARTY DATA

| Name: | SONY CORPORATION | |
|-----------------|---------------------------|--|
| Street Address: | s: 1-7-1 Konan, Minato-ku | |
| City: | Tokyo | |
| State/Country: | JAPAN | |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 12246028 |

CORRESPONDENCE DATA

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| ATTORNEY DOCKET NUMBER: | 09812.1355 |
|-------------------------|---------------|
| NAME OF SUBMITTER: | David W. Hill |

Total Attachments: 2

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PATENT REEL: 021875 FRAME: 0455

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S08P1817US00 09812.1355

| Docket Number: |
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| ASSIGNMENT |
| WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in IMAGE PROCESSING DEVICE AND IMAGE PROCESSING METHOD |
| for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my nan and address; |
| AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be grant therefor in the United States and in any and all foreign countries; |
| NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration the receipt and sufficience of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title an interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Lette Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priori rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of American adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto; |
| And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to n and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said inventio applications and Letters Patent of the United States and countries foreign thereto; |
| And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawf papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require at prepare at its own expense; |
| And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and document relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known as accessible to me and will testify as to the same in any interference or litigation related thereto; |
| And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale. |
| And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date this application in the spaces that follow: Serial Number:, Filing Date: |
| This assignment executed on the dates indicated below. |
| Yuji WADA September 16, 2008 Name of first or sole inventor Execution date of U.S. Patent Application |
| Name of first or sole inventor Execution date of U.S. Patent Application |
| Tokyo, Japan |
| Residence of first or sole inventor |
| , |

Signature of first or sole inventor

PATENT REEL: 021875 FRAME: 0456

| _Takao NOZAWA | South 11 and |
|------------------------------|---|
| Name of second inventor | Execution date of U.S. Patent Application |
| Tokyo, Japan | , ipplication |
| Residence of second inventor | |
| Japan Morana | latanla 1/ 200 |
| Signature of second inventor | September 16, 2008 Date of this assignment |
| | Date of this assignment |
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| Name of third inventor | Execution date of U.S. Patent Application |
| • | Execution date of O.S. Patent Application |
| Residence of third inventor | |
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| Signature of third inventor | Date of this assignment |
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| Name of fourth inventor | Execution date of U.S. Patent Application |
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| Residence of fourth inventor | |
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| Signature of fourth inventor | Date of this assignment |
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| Name of fifth inventor | Execution date of U.S. Patent Application |
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| Residence of fifth inventor | |
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| Signature of fifth inventor | Date of this assignment |

PATENT REEL: 021875 FRAME: 0457

RECORDED: 11/21/2008